

### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>A</sub> = +25°C
60V	140mΩ @ V <sub>GS</sub> = 10V	2.3A
607	170mΩ @ V <sub>GS</sub> = 4.5V	2.1A

## **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- DC-DC converters
- Power-management functions
- Analog switches

## **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN6140LQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

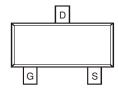
### **Mechanical Data**

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)

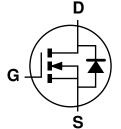




Top View



Pin Configuration



**Equivalent Circuit** 

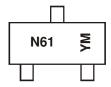
### **Ordering Information** (Note 4)

I	Part Number	Paskaga	Packing			
	Fart Number	Package	Qty.	Carrier		
	DMN6140LQ-7	SOT23	3,000	Tape & Reel		
	DMN6140LQ-13	SOT23	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/support/packaging/diodes-packaging/support/support/suppo$

## **Marking Information**



 $\begin{array}{ll} N61 = Product\ Type\ Marking\ Code \\ YM = Date\ Code\ Marking \\ Y\ or\ \overline{Y} = Year\ (ex:\ K = 2023) \\ M = Month\ (ex:\ 9 = September) \end{array}$ 

Date Code Key

Year	2015	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	С	-	K	L	М	N	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	60	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V	
		T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	1.6 1.2	Α
Continuous Drain Current (Note 5) VGS = 10V	ous Drain Current (Note 5) V <sub>GS</sub> = 10V			2.0 1.6	Α
Steady $T_A = +25^{\circ}$ Continuous Prain Courant (Note C) // 10 // State $T_A = +70^{\circ}$ C			l <sub>D</sub>	2.3 1.8	Α
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	lo	2.9 2.3	Α		
Maximum Continuous Body Diode Forward Curren	t (Note 6)	Is	1.5	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 19	6)		I <sub>DM</sub>	10	А

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	Po	0.7	W	
Total Fower Dissipation (Note 5)	$T_A = +70$ °C	PD	0.4	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	183	°C/W	
Thermal Resistance, Junction to Ambient (Note 3)	t < 10s	$R_{ heta JA}$	115	G/ <b>VV</b>	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	$P_{D}$	1.3	W	
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	רט	0.8		
Thermal Peciatones, Junction to Ambient (Note 6)	Steady State		94		
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	Rеja	61	°C/W	
Thermal Resistance, Junction to Case		Rejc	39		
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Dag (a)		92	140	mΩ	$V_{GS} = 10V, I_D = 1.8A$	
Static Dialif-Source Off-Nesistance	R <sub>DS(ON)</sub>	_	115	170	11122	$V_{GS} = 4.5V, I_{D} = 1.3A$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	2.2	_	S	$V_{DS} = 15V, I_D = 1.8A$	
Diode Forward Voltage	VsD	_	0.75	1.0	V	$V_{GS} = 0V, I_{S} = 0.45A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	315	_		V 40V V 0V	
Output Capacitance	Coss	_	18		pF	$V_{DS} = 40V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	16	_		1 = 1.01/1112	
Gate Resistance	Rg	_	0.65	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	8.6	_			
Total Gate Charge (V <sub>GS</sub> = 5V)	$Q_g$	_	4.1	_	nC   Vps = 30V, lp = 1.8A		
Gate-Source Charge	Qgs	_	1.0	_	110	$V_{DS} = 30V, I_{D} = 1.8A$	
Gate-Drain Charge	Qgd	_	1.7	_			
Turn-On Delay Time	td(ON)	_	2.6	_			
Turn-On Rise Time	tR	_	3.6	_	20	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 10V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	16.3	_	ns	$R_G = 6.0\Omega$ , $I_D = 1.8A$	
Turn-Off Fall Time	tF	_	2.7	_			
Reverse Recovery Time	t <sub>RR</sub>	_	16.8	_	ns	L 1 00 di/dt 1000///	
Reverse Recovery Charge	Qrr	_	9.0	_	nC	IF = 1.8A, di/dt =100A/μs	

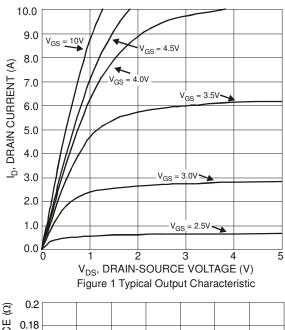
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

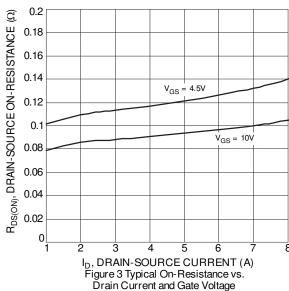
<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1in. square copper plate.

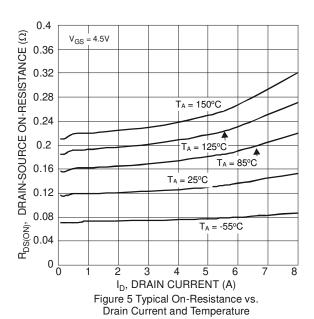
<sup>7.</sup> Short duration pulse test used to minimize self-heating effect.

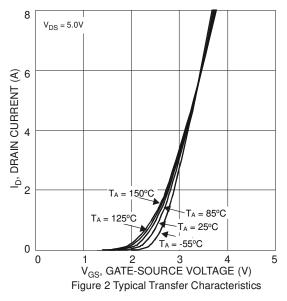
<sup>8.</sup> Guaranteed by design. Not subject to production testing.

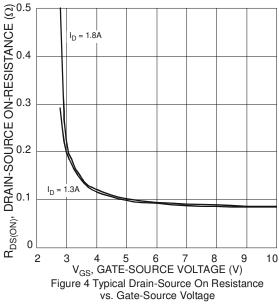












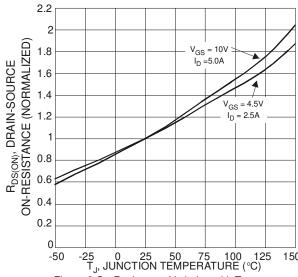
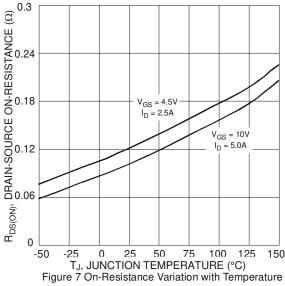
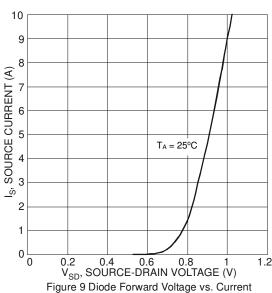
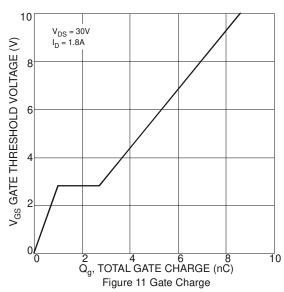


Figure 6 On-Resistance Variation with Temperature









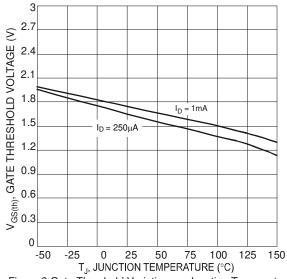
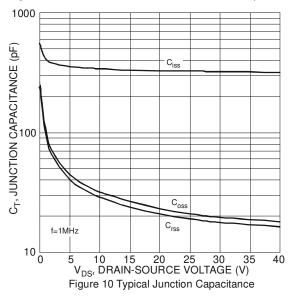
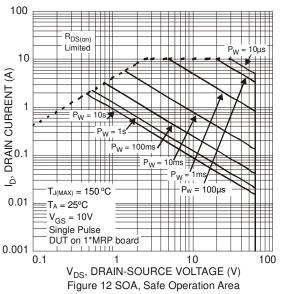
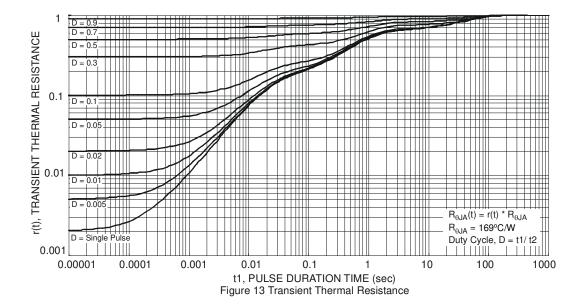


Figure 8 Gate Threshold Variation vs. Junction Temperature







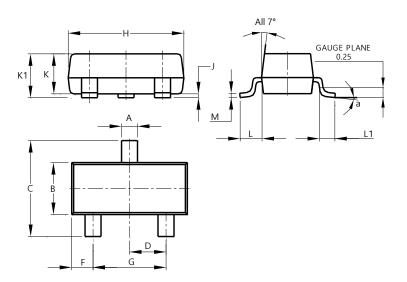




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23

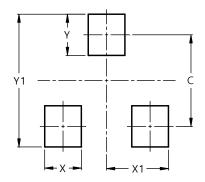


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All	Dimens	ions in	mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
Y1	2.9



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